



Customer Information Notification

202005036I

Issue Date: 19-Jun-2020

Effective Date: 20-Jul-2020

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.



QUALITY

Change Category

- | | | | | |
|--|---|---|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input checked="" type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

i.MX6D/Q Product Final Test Site Expansion from NXP-ATTJ to ASECL

Description

NXP Semiconductors announces the Final Test site expansion for the i.MX6D/Q Product associated with this notification, from the current NXP ATTJ, Tianjin, China Final Test site to the ASE, Chung-Li, Taiwan Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Reason

Qualification of ASE, Chung-Li, Taiwan is required for manufacturing flexibility and customer supply assurance.

ASECL is already qualified for final test of Auto products.

ASECL is qualified as an alternative test site for i.MX6D/Q, and gives NXP another final test option for this product.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Leon Sun

Position Product Engineer

e-mail address liang.sun_1@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
MCIMX6D5EYM12AD	935311654557	MCIMX6D5EYM12AD	i.MX6D	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6D7CVT08AD	935315236557	MCIMX6D7CVT08AD	i.MX6D	SOT1643-1	FBGA624	RFS	Apps Processors
MCIMX6Q5EYM12AD	935323494557	MCIMX6Q5EYM12AD	i.MX6Q	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6D5EYM10AE	935357864557	MCIMX6D5EYM10AE	i.MX6D ROM Perf Enhance	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q5EYM10AE	935357869557	MCIMX6Q5EYM10AE	i.MX6Q ROM Perf Enhance	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q7CVT08AC	935311044557	MCIMX6Q7CVT08AC	i.MX6Q	SOT1643-1	FBGA624	RFS	Apps Processors
MCIMX6Q7CVT08AE	935354334557	MCIMX6Q7CVT08AE	i.MX6Q ROM Perf Enhance	SOT1643-1	FBGA624	RFS	Apps Processors
MCIMX6D5EYM10AC	935323467557	MCIMX6D5EYM10AC	i.MX6D	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q5EYM10AD	935321953557	MCIMX6Q5EYM10AD	i.MX6Q	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q7CVT08AD	935324758557	MCIMX6Q7CVT08AD	i.MX6Q	SOT1643-1	FBGA624	RFS	Apps Processors
MCIMX6D5EYM10AD	935315182557	MCIMX6D5EYM10AD	i.MX6D	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q5EYM10AC	935314761557	MCIMX6Q5EYM10AC	i.MX6Q	SOT1642-1	LFBGA624	RFS	Apps Processors
MCIMX6Q5EYM10ADR	935321953518	MCIMX6Q5EYM10ADR	i.MX6Q	SOT1642-1	LFBGA624	RFS	Apps Processors